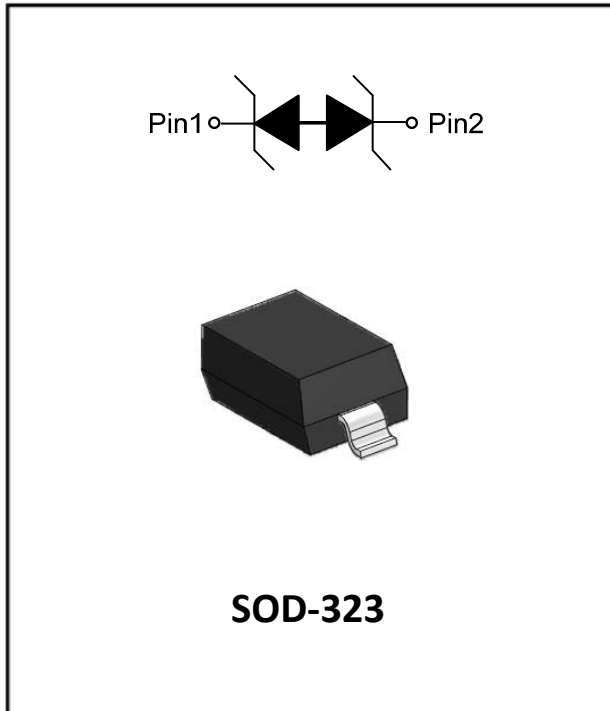


1- Line, Bi-directional, Transient Voltage Suppressor



Features

- Stand-off voltage: 12V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 10A (8/20 μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

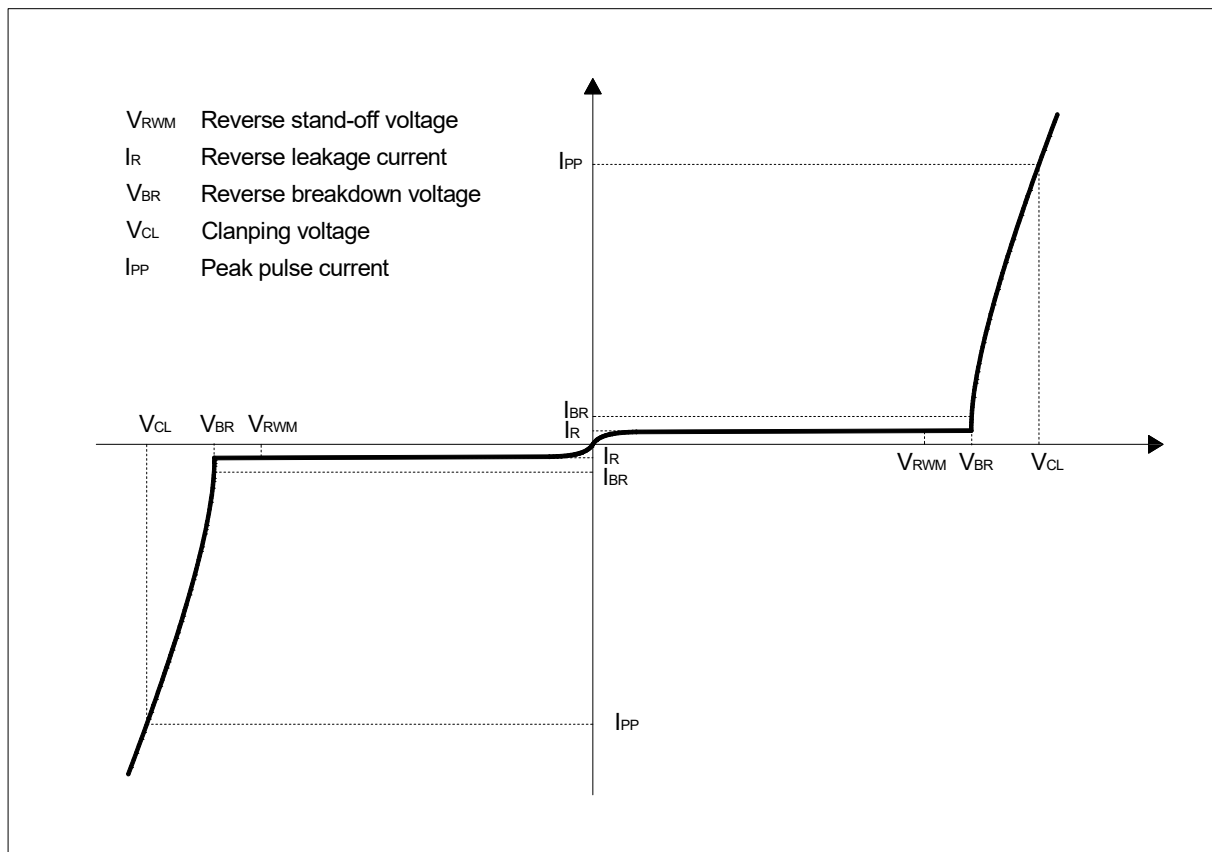
- Cellular Handsets and Accessories
- Personal Digital Assistants
- Notebooks and Handhelds
- Portable Instrumentation
- Peripherals
- Pagers Peripherals
- Desktop and Servers

Mechanical Data

- Package: SOD-323
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics





ESD12VD3B

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	280	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	10	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				12
Reverse leakage current	I_R	μA	$V_{RWM} = 12V$			0.5
Reverse breakdown voltage	V_{BR}	V	$I_{BR} = 1mA$	13		18
Clamping voltage ²⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$			20
		V	$I_{PP} = 10A, t_p = 8/20\mu s$			28
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		30	50

Notes:

- (1). TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
- (2). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD12VD3B	F2	Approximate 4	3000	30000	120000	7" reel



■ Characteristics (Typical)

Fig.1 8/20 μ s waveform per IEC61000-4-5

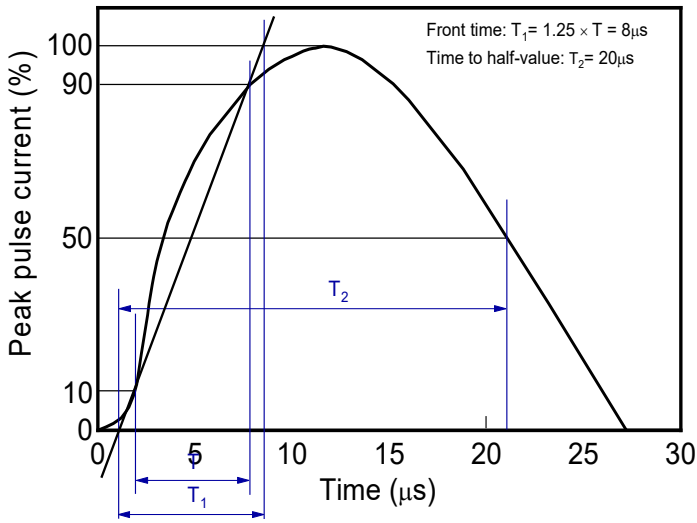


Fig.2 Contact discharge current waveform per IEC61000-4-2



Fig.3 Clamping voltage vs. Peak pulse current

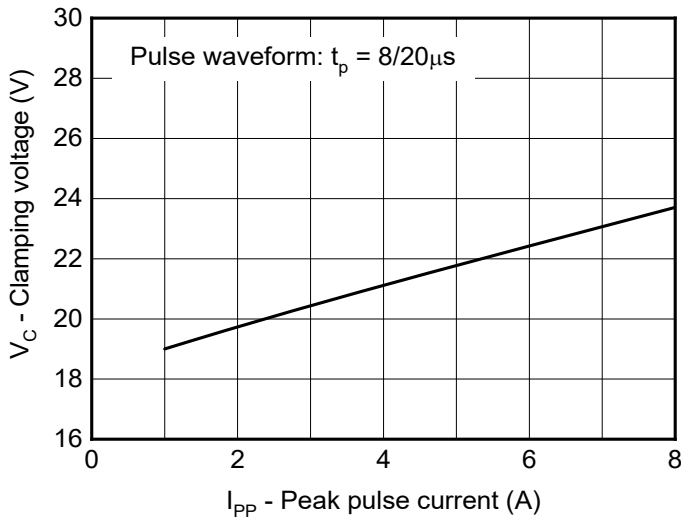


Fig.4 Capacitance vs. Reverse voltage

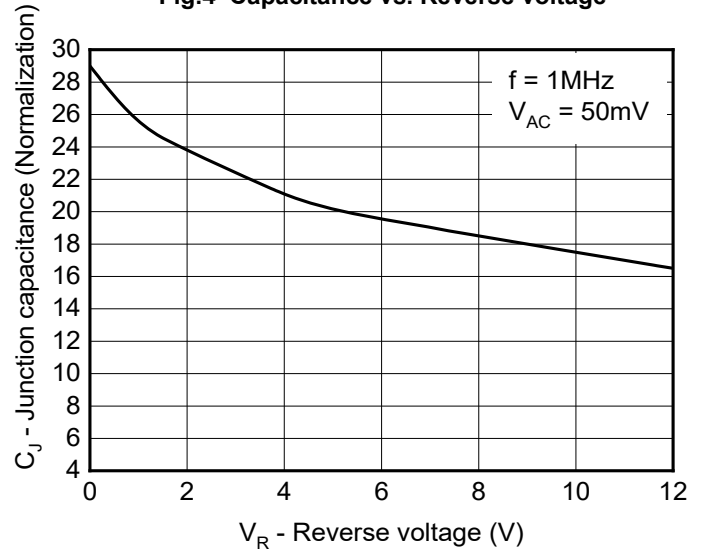


Fig.5 Non-repetitive peak pulse power vs. Pulse time

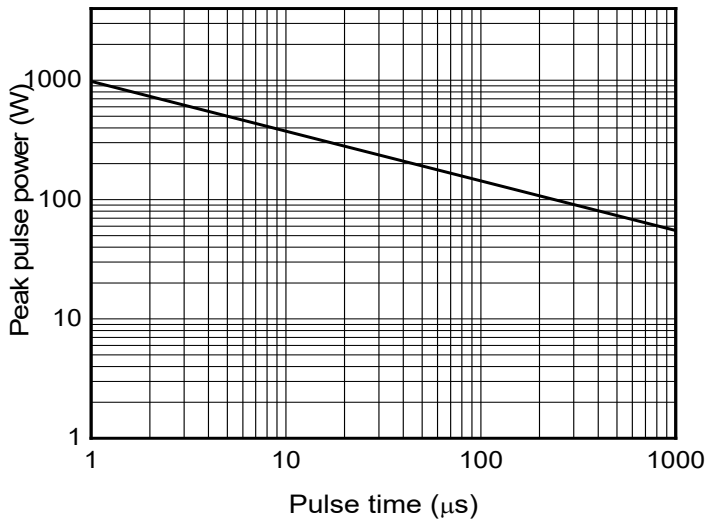


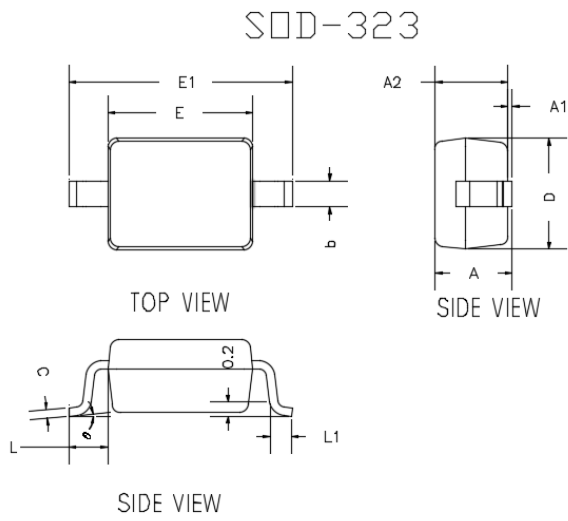
Fig.6 Power derating vs. Ambient temperature





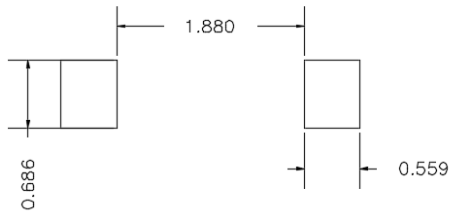
ESD12VD3B

■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	---	0.0393	---	1.0000
A1	0.0000	0.0039	0.0000	0.1000
A2	0.0314	0.0354	0.8000	0.9000
b	0.0098	0.0157	0.2500	0.4000
c	0.0031	0.0059	0.0800	0.1500
D	0.0472	0.0551	1.2000	1.4000
E	0.0629	0.0709	1.6000	1.8000
E1	0.0984	0.1063	2.5000	2.7000
L	0.0187TYP		0.475TYP	
L1	0.0098	0.0157	0.250	0.400
e	0°	8°	0°	8°

■ Soldering Footprint



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT



ESD12VD3B

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